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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/665,219		09/17/2003	Whonchee Lee	108298705US 6284	
25096	7590	02/21/2006		EXAMINER	
PERKINS	COIE LL	.P	NGUYEN, DUNG V		
PATENT-S	EA				
P.O. BOX 1	247			ART UNIT	PAPER NUMBER
SEATTLE,	WA 981	11-1247	3723	<del></del>	
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DATE MAILED: 02/21/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	
	10/665,219	LEE ET AL.	
Office Action Summary	Examiner	Art Unit	
	Dung V. Nguyen	3723	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence add	lress
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period w  - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this cor D (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on 29 M     This action is FINAL. 2b)☑ This     Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro		merits is
Disposition of Claims			
4) □ Claim(s) 2-25,27-57 and 72 is/are pending in the same states of the above claim(s) is/are withdraw 5) □ Claim(s) 2-10,12-25,27-57 and 72 is/are allowed 6) □ Claim(s) 11 is/are rejected.  7) □ Claim(s) is/are objected to.  8) □ Claim(s) are subject to restriction and/or	vn from consideration. ed.		
Application Papers			
9)☐ The specification is objected to by the Examine 10)☒ The drawing(s) filed on <u>17 September 2003</u> is/a Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11)☐ The oath or declaration is objected to by the Ex	are: a) $\square$ accepted or b) $\square$ object drawing(s) be held in abeyance. Section is required if the drawing(s) is object.	e 37 CFR 1.85(a). jected to. See 37 CFI	R 1.121(d).
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicati ity documents have been receive ı (PCT Rule 17.2(a)).	ion No ed in this National S	Stage
Attachment(s)  Notice of References Cited (PTO-892)  Notice of Draftsperson's Patent Drawing Review (PTO-948)  Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date 11/29/05.	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ate	.152)

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### **DETAILED ACTION**

1. The indicated allowability of claim 11 is withdrawn in view of the newly discovered reference(s) to Emesh et al (US 2002/0108861). Rejections based on the newly cited reference(s) follow.

## Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claim 11 is rejected under 35 U.S.C. 102(b) as being anticipated by Emesh et al (US 2002/0108861). Emesh et al discloses a method for removing material 80 from a microelectronic substrate 60 comprising disposing an electrolytic liquid between an electrically conductive material 80 of the microelectronic substrate 60 and an electrode 70, the electrolytic liquid having water and methanol as a constituent, contacting the microelectronic substrate 60 with a polishing pad material 40, electrically coupling the conductive material 80 of the microelectronic substrate 60 to a source of electrical signal 90 via the electronic liquid and the electrode 70, applying a varying electrical signal to the conductive material 80, moving the polishing pad material 40 or the microelectronic substrate 60, removing the conductive material 80 from the microelectronic substrate 60 while the electrolytic liquid is adjacent to the electrically conductive material 80 (note Fig. 4, paragraph [0035] to [0042] and [0054] to [0057]).

## Allowable Subject Matter

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4. Claims 2-10, 12-25, 27-57 and 72 are allowed.

#### Conclusion

5. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Dabral et al and Sato et al' 623 and '227 are cited to show method for electro-chemical polishing microelectronic substrate.

- 6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dung V. Nguyen whose telephone number is 571-272-4490. The examiner can normally be reached on M-F, 7:00-3:30.
- 7. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Joseph J. Hail can be reached on 571-272-4485. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.
- 8 Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

mg vom hangm DUNG VAN NGUYEN PRIMARY EXAMINER

DVN